



DMP2036UVT

Product Summary

BV _{DSS}	RDS(ON) Max	I _{D Max} T _A = +25°C
-20V	$30m\Omega @ V_{GS} = -4.5V$	-6.0A
-20V	39mΩ @ V _{GS} = -2.5V	-5.5A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- **DC-DC** Converters
- Motor Control
- **Power Management Functions**
- Analog Switch

Features and Benefits

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

P-CHANNEL ENHANCEMENT MODE MOSFET

Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.013 grams (Approximate)

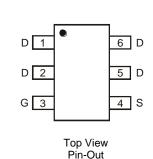


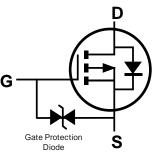


TSOT26



Top View





Equivalent Circuit

Ordering Information (Note 4)

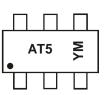
	Part Number	Case	Packaging		
	DMP2036UVT-7	TSOT26	3,000/Tape & Reel		
DMP2036UVT-13		TSOT26	10,000/Tape & Reel		
Notes:	: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.				

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen - and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



AT5 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Kev

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Year	2017	2018	2	019	2020	2021	I	2022	2023	20	24	2025
Code	E	F		G	Н	I		J	K	L	-	М
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	-20	V
Gate-Source Voltage		V _{GSS}	±8	V
Continuous Drain Current (Note 6) V_{GS} = -4.5V	ID	-6.0 -5.0	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	-40	А
Continuous Source-Drain Diode Current (Note 6)		Is	-2,2	А
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	-21	А	
Avalanche Energy (Note 7) L = 0.1mH	E _{AS}	23	mJ	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Dower Dissipation (Note 5)	T _A = +25°C	D	1.1	14/	
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	PD	0.7	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	108	°C/W	
Total Dawar Discinction (Note 6)	T _A = +25°C	D	1.5	W	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	PD	1.0		
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	81	°C/W	
Thermal Resistance, Junction to Case (Note 6) Stea		R _{θJC}	16	C/W	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

			_			
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)				1	r	
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	—	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	—	_	-1	μA	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	—	—	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	-0.4		-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
			24	30		$V_{GS} = -4.5V, I_D = -6.4A$
Static Drain-Source On-Resistance	R _{DS(ON)}	—	31	39	mΩ	$V_{GS} = -2.5V, I_D = -4.8A$
			41	58		$V_{GS} = -1.8V, I_D = -2.5A$
Diode Forward Voltage	V _{SD}	—	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1.0A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	—	1,808	—		
Output Capacitance	C _{oss}	—	155	—	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	117	—		
Gate Resistance	Rg	—	32	—	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	—	20.5	—		
Gate-Source Charge	Q _{gs}	—	2.8	—	nC	$V_{DS} = -10V, V_{GS} = -4.5V,$
Gate-Drain Charge	Q _{qd}	—	4.1	—		$I_{\rm D} = -4.0 {\rm A}$
Turn-On Delay Time	t _{D(ON)}	—	9.1	—		
Turn-On Rise Time	t _R	—	12.3	—		$V_{DS} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(OFF)}	—	120	—	ns	$R_{g} = 6\Omega, I_{D} = -1.0A$
Turn-Off Fall Time	tF	—	54	—		-
Reverse Recovery Time	t _{RR}	—	23.1	_	ns	I _F = -1.0A, di/dt = 100A/μs
Reverse Recovery Charge	Q _{RR}	_	8.3	_	nC	I _F = -1.0A, di/dt = 100A/µs

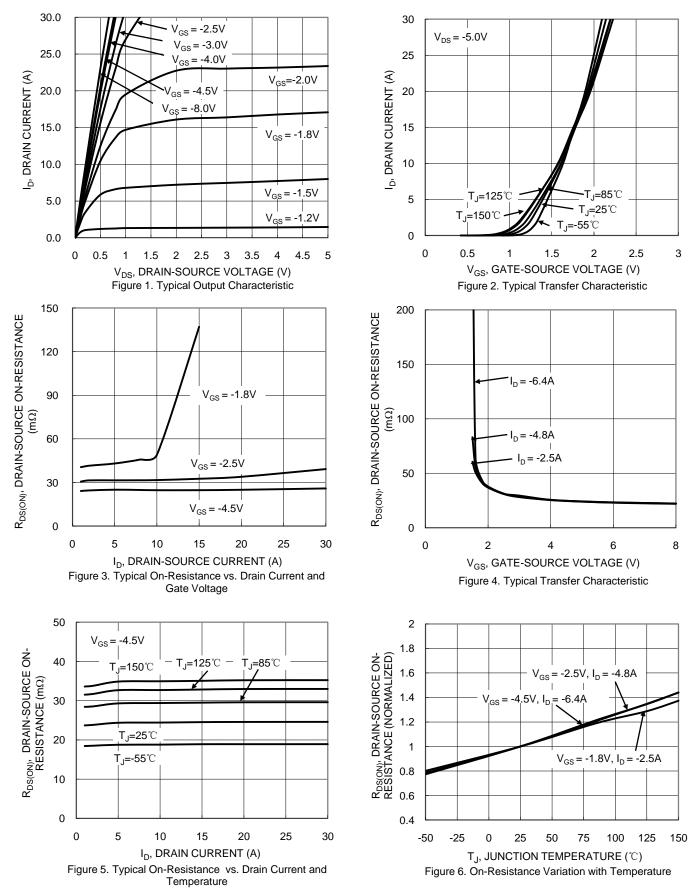
5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate. 7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}$ C. Notes:

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.



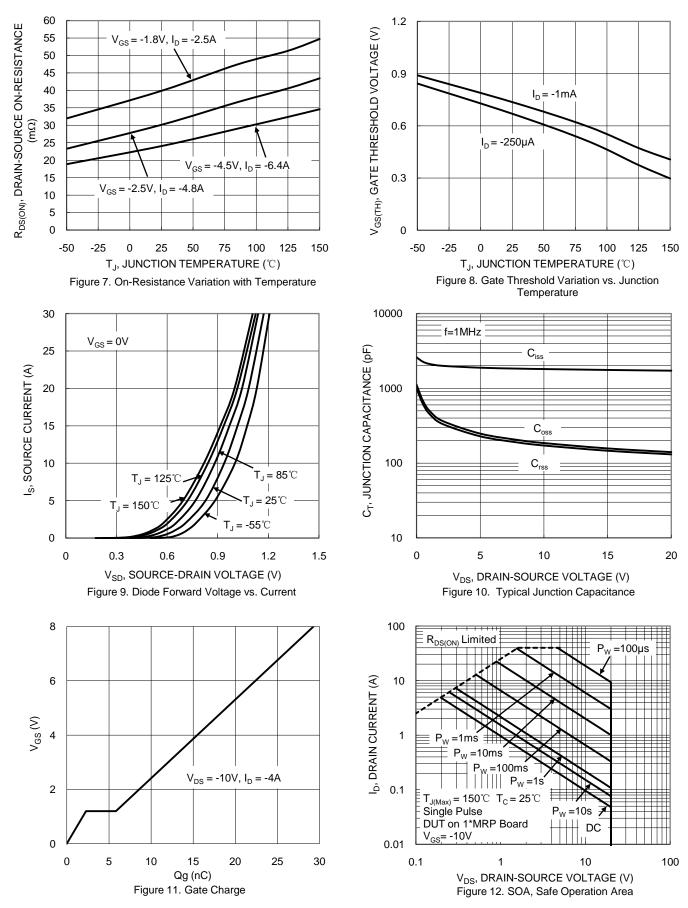
DMP2036UVT



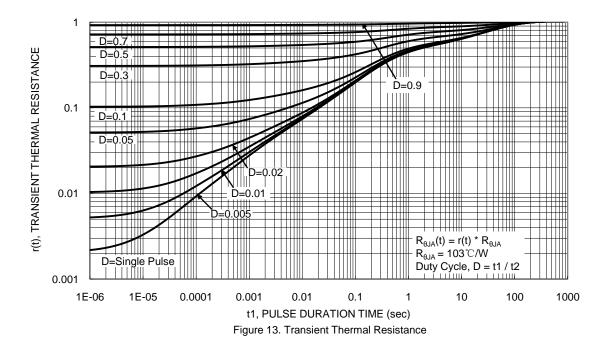
DMP2036UVT Document number: DS40059 Rev. 2 - 2



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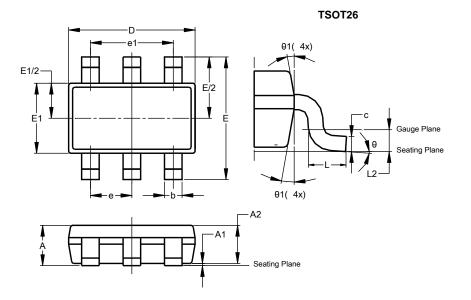






Package Outline Dimensions

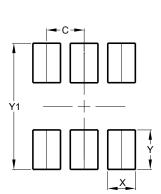
Please see http://www.diodes.com/package-outlines.html for the latest version.



	TSOT26						
Dim	Min Max Typ						
Α	-	1.00	-				
A1	0.010	0.100	-				
A2	0.840	0.900	-				
D	2.800	3.000	2.900				
ш	2	.800 BS	С				
E1	1.500	1.700	1.600				
b	0.300	0.300 0.450					
C	0.120	0.200	-				
e	0.950 BSC						
e1	1	.900 BS	С				
L	0.30	0.50	-				
L2	0	.250 BS	С				
θ	0°	0° 8° 4°					
θ1	4°	12°	-				
A	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26

Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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